

BIPOLAR ANALOG INTEGRATED CIRCUIT

μ PC4559

HIGH PERFORMANCE DUAL OPERATIONAL AMPLIFIER

DESCRIPTION

The μ PC4559 is a dual type operational amplifier having better slew rate and bandwidth than the μ PC4558C with satisfying unity gain frequency compensation. Having low noise characteristics, this device is very convenient to make active filters and other audio application circuits.

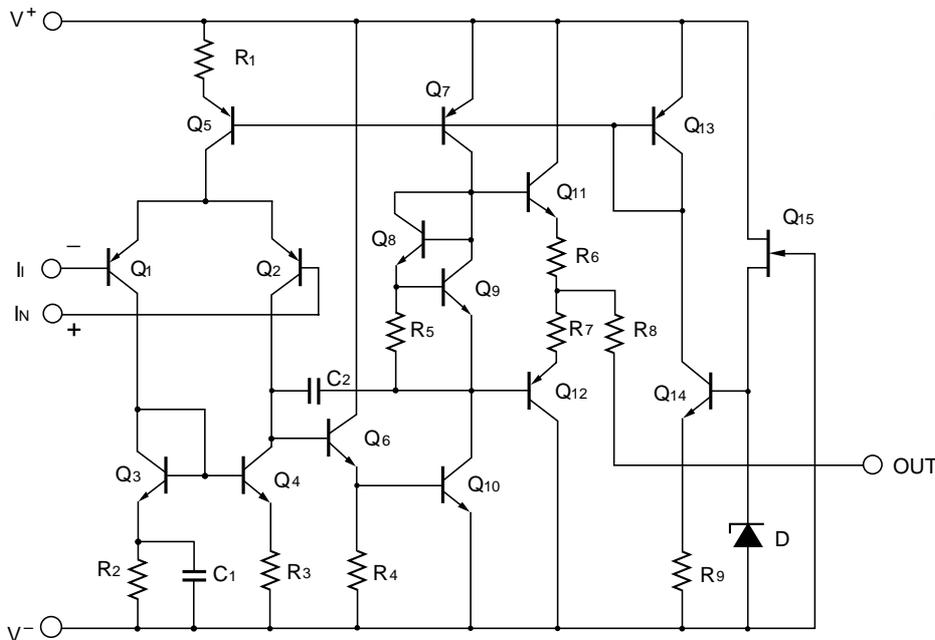
FEATURES

- Internal frequency compensation
- Low noise
- Output short circuit protection

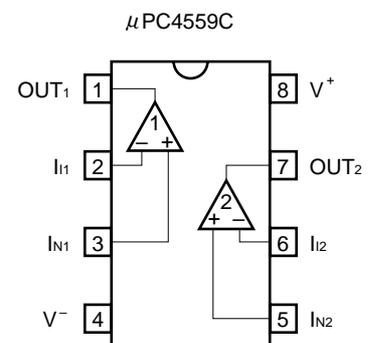
ORDERING INFORMATION

Part Number	Package
μ PC4559C	8-pin plastic DIP (7.62 mm (300))

EQUIVALENT CIRCUIT (1/2 Circuit)



PIN CONFIGURATION (Top View)



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 Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C)

Parameter	Symbol	Ratings	Unit
Voltage between V ⁺ and V ⁻ ^{Note 1}	V ⁺ - V ⁻	-0.3 to +36	V
Differential Input Voltage	V _{ID}	±30	V
Input Voltage ^{Note 2}	V _I	V ⁻ -0.3 to V ⁺ +0.3	V
Output Voltage ^{Note 3}	V _O	V ⁻ -0.3 to V ⁺ +0.3	V
Power Dissipation ^{Note 4}	P _T	350	mW
Output Short Circuit Duration ^{Note 5}		Indefinite	sec
Operating Ambient Temperature	T _A	-20 to +80	°C
Storage Temperature	T _{stg}	-55 to +125	°C

- Notes**
- Reverse connection of supply voltage can cause destruction.
 - The input voltage should be allowed to input without damage or destruction. Even during the transition period of supply voltage, power on/off etc., this specification should be kept. The normal operation will establish when the both inputs are within the Common Mode Input Voltage Range of electrical characteristics.
 - This specification is the voltage which should be allowed to supply to the output terminal from external without damage or destructive. Even during the transition period of supply voltage, power on/off etc., this specification should be kept. The output voltage of normal operation will be the Output Voltage Swing of electrical characteristics.
 - Thermal derating factor is -5.0 mW/°C when ambient temperature is higher than 55°C.
 - Pay careful attention to the total power dissipation not to exceed the absolute maximum ratings, Note 4.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	V [±]	±4		±16	V

ELECTRICAL SPECIFICATIONS (T_A = 25°C, V[±] = ±15 V)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input Offset Voltage	V _{IO}	R _S ≤ 10 Ω		±0.5	±6.0	mV
Input Offset Current ^{Note}	I _{IO}			±5	±200	nA
Input Bias Current ^{Note}	I _B			60	500	nA
Large Signal Voltage Gain	A _V	R _L ≥ 20 kΩ, V _O = ±10 V	20,000	100,000		
Power Consumption	P _d	I _O = 0 A, Both Amplifiers		90	170	mW
Common Mode Rejection Ratio	CMR	R _S ≤ 10 kΩ	70	90		dB
Supply Voltage Rejection Ratio	SVR	R _S ≤ 10 kΩ		30	150	μV/V
Output Voltage Swing	V _{om}	R _L ≥ 10 kΩ	±12	±14		V
		R _L ≥ 2 kΩ	±10	±13		V
Common Mode Input Voltage Range	V _{ICM}		±12	±14		V
Slew Rate	SR	A _V = 1		2.0		V/μs
Input Equivalent Noise Voltage	V _n	R _S = 1 kΩ, f = 1 Hz to 1 kHz (Figure1)		6		μV _{p-p}
Channel Separation		f = 1 kHz (Figure2)		105		dB

Note Input bias currents flow out from IC, because each currents are base current of PNP-transistor on input stage.

MEASUREMENT CIRCUIT

Figure1 Noise Measurement Circuit

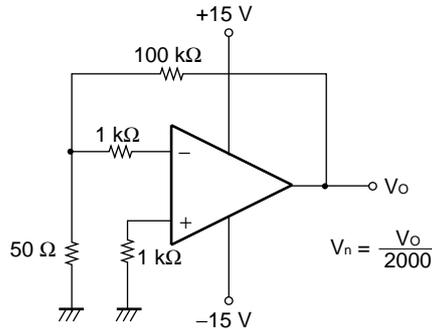
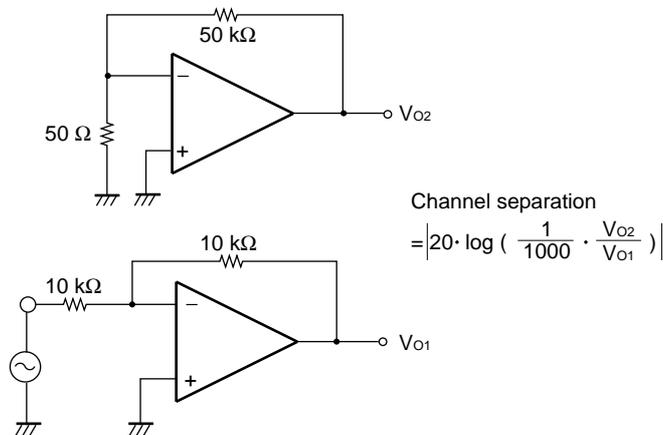
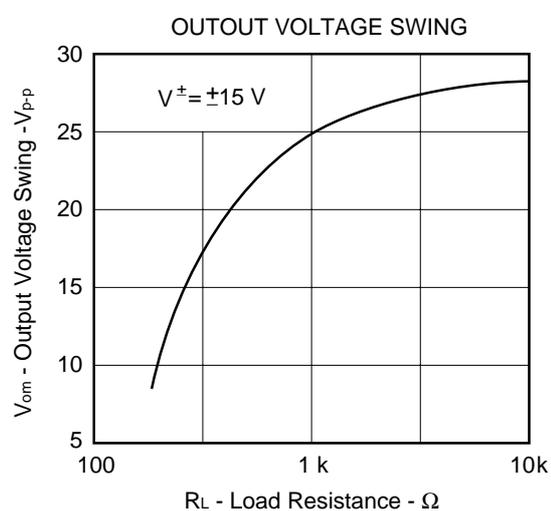
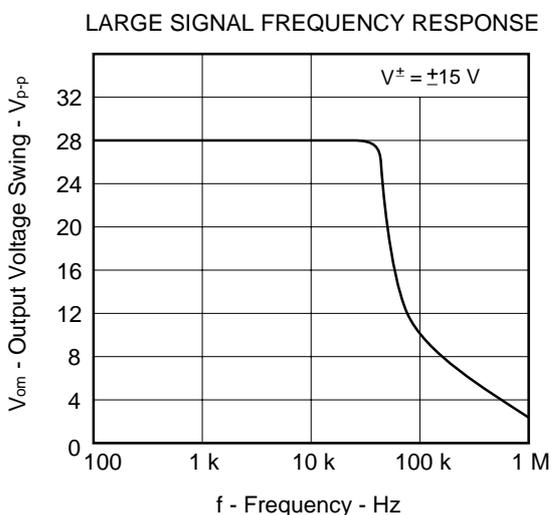
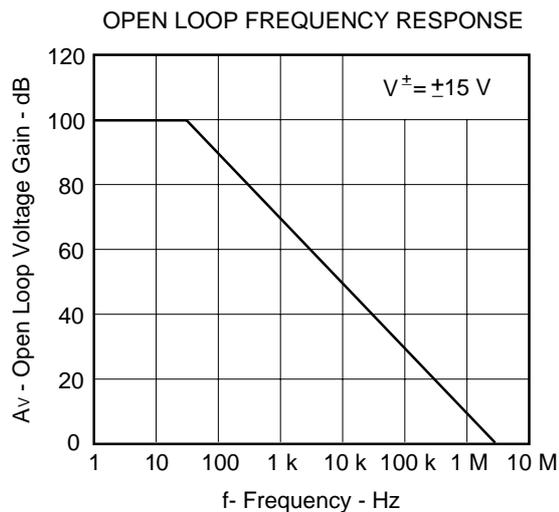
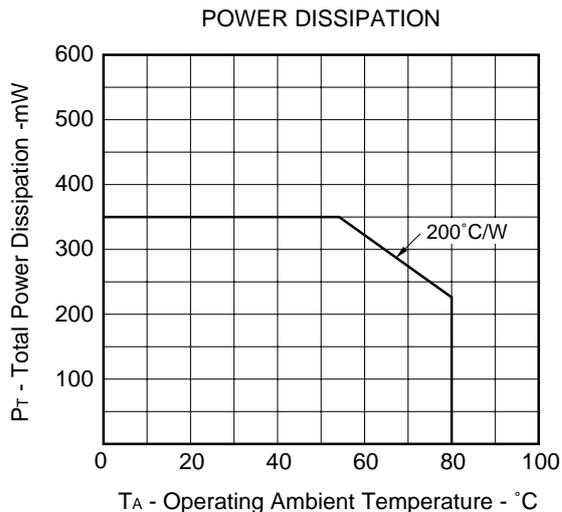


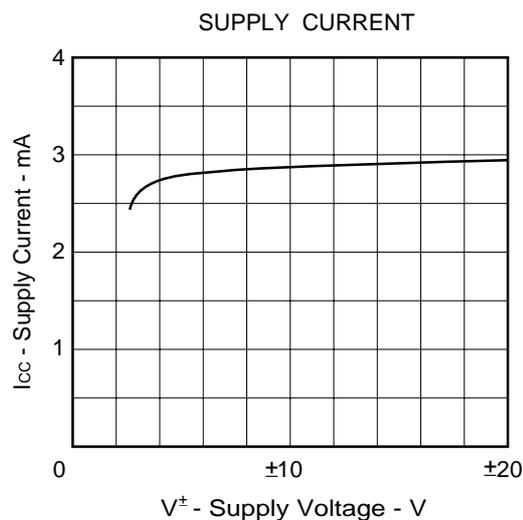
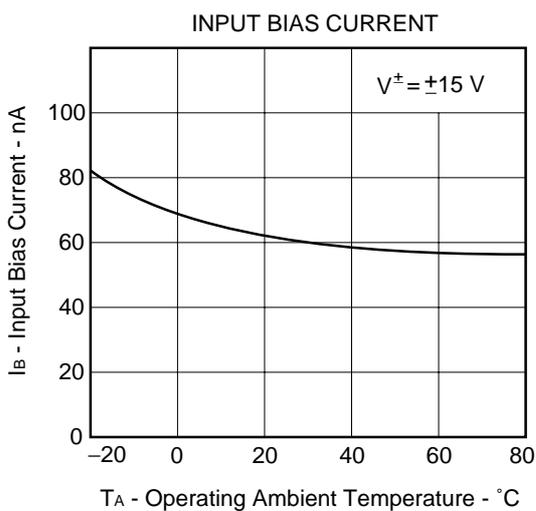
Figure2 Channel Separation Measurement Circuit



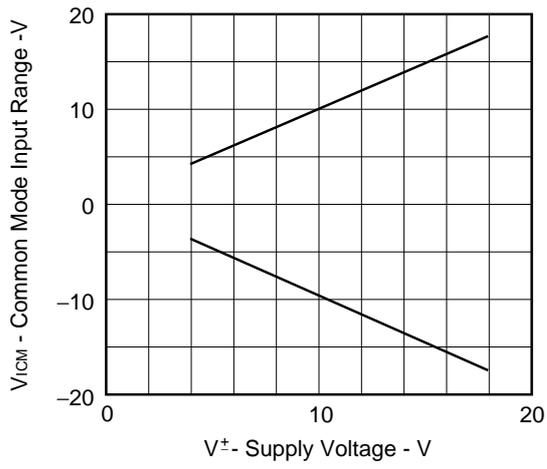
TYPICAL PERFORMANCE CHARACTERISTICS ($T_A = 25^\circ\text{C}$, TYP.)



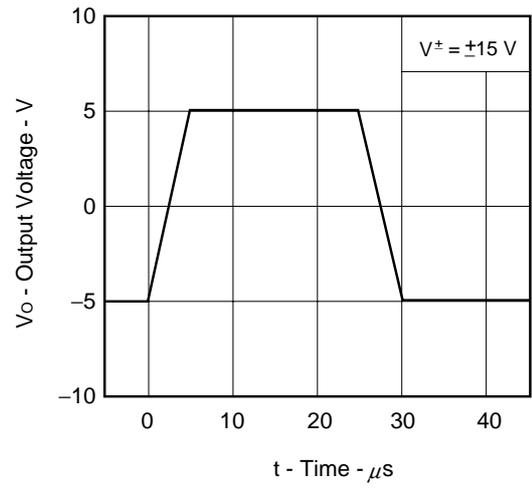
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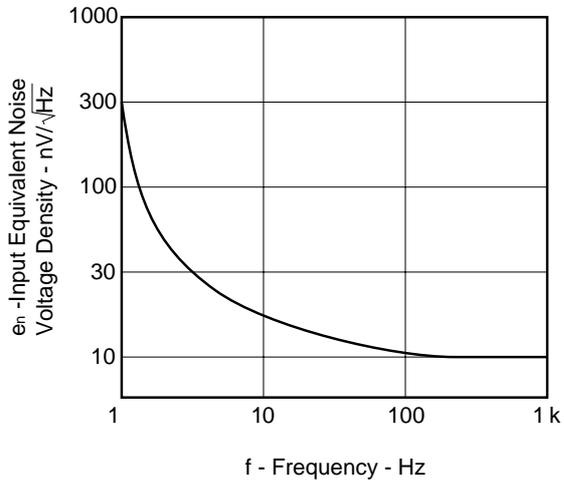
COMMON MODE INPUT VOLTAGE RANGE



VOLTAGE FOLLOWER PULSE RESPONSE

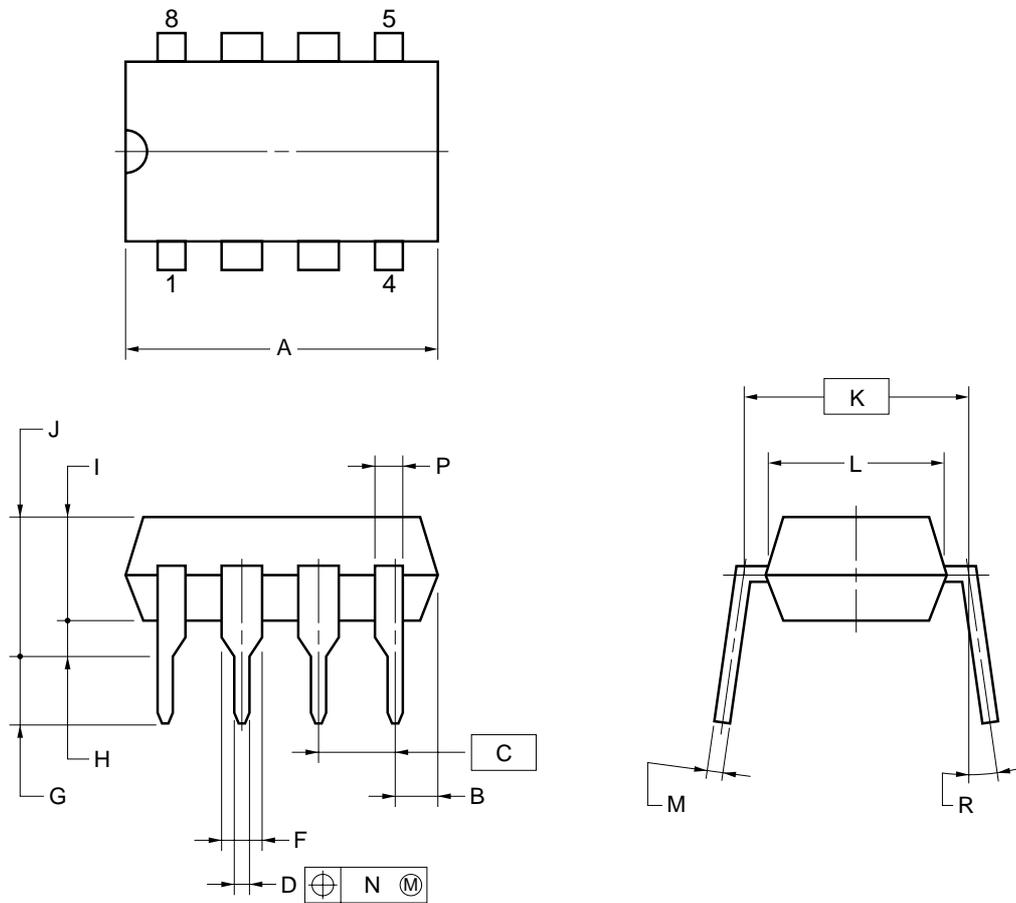


INPUT EQUIVALENT NOISE VOLTAGE DENSITY



PACKAGE DRAWING (Unit : mm)

8-PIN PLASTIC DIP (7.62mm(300))



NOTES

1. Each lead centerline is located within 0.25 mm of its true position (T.P.) at maximum material condition.
2. Item "K" to center of leads when formed parallel.

ITEM	MILLIMETERS
A	10.16 MAX.
B	1.27 MAX.
C	2.54 (T.P.)
D	0.50±0.10
F	1.4 MIN.
G	3.2±0.3
H	0.51 MIN.
I	4.31 MAX.
J	5.08 MAX.
K	7.62 (T.P.)
L	6.4
M	0.25 ^{+0.10} _{-0.05}
N	0.25
P	0.9 MIN.
R	0-15°

P8C-100-300B,C-2

★ **RECOMMENDED SOLDERING CONDITIONS**

When soldering this product, it is highly recommended to observe the conditions as shown below. If other soldering processes are used, or if the soldering is performed under different conditions, please make sure to consult with our sales offices.

For more details, refer to our document "**SEMICONDUCTOR DEVICE MOUNTING TECHNOLOGY MANUAL (C10535E)**".

Type of Through-hole Device

μPC4559C: 8-pin plastic DIP (7.62 mm (300))

Process	Conditions
Wave Soldering (only to leads)	Solder temperature: 260°C or below, Flow time: 10 seconds or less.
Partial Heating Method	Pin temperature: 300°C or below, Heat time: 3 seconds or less (per each lead).

Caution For through-hole device, the wave soldering process must be applied only to leads, and make sure that the package body does not get jet soldered.

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